

## LM3704/LM3705

# Microprocessor Supervisory Circuits with Power Fail Input, Low Line Output and Manual Reset

### General Description

The LM3704/LM3705 series of microprocessor supervisory circuits provide the maximum flexibility for monitoring power supplies and battery controlled functions in systems without backup batteries. The LM3704/LM3705 series are available in MSOP-10 and 9-bump micro SMD packages.

Built-in features include the following:

Reset: Reset is asserted during power-up, power-down, and brownout conditions. RESET is guaranteed down to  $V_{CC}$  of 1.0V.

Manual Reset Input: An input that asserts reset when pulled low.

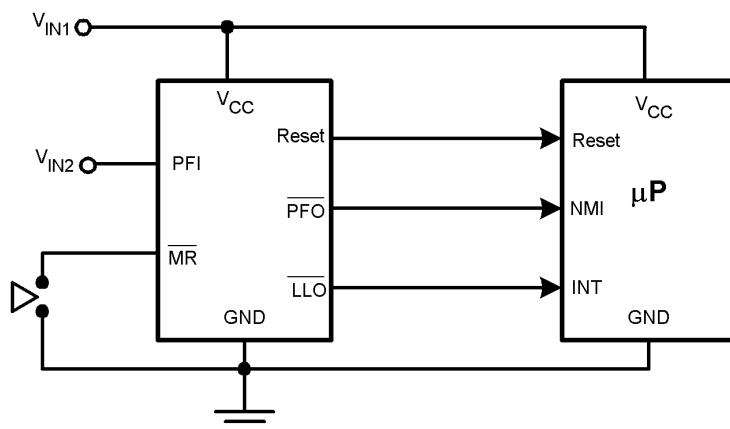
Power-Fail Input: A 1.225V threshold detector for power fail warning, or to monitor a power supply other than  $V_{CC}$ .

Low Line Output: This early power failure warning indicator goes low when the supply voltage drops to a value which is 2% higher than the reset threshold voltage.

### Features

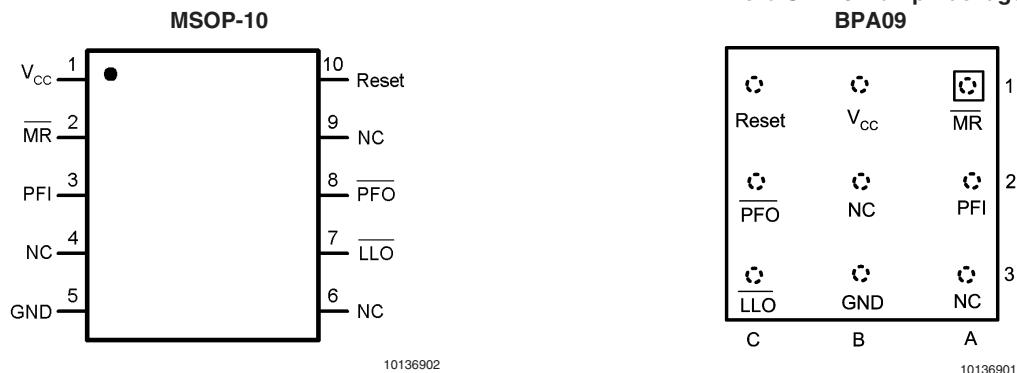
- Standard Reset Threshold voltage: 3.08V
- Custom Reset Threshold voltages: For other voltages between 2.2V and 5.0V in 10mV increments, contact National Semiconductor Corp.

### Typical Application



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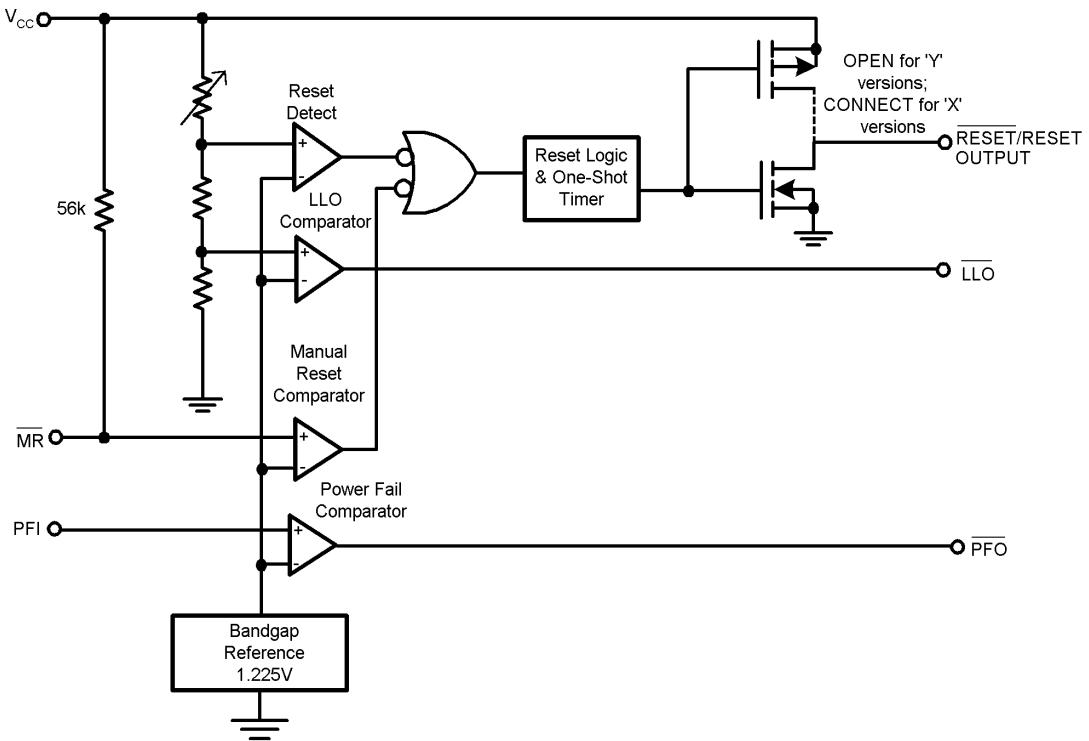
## Connection Diagram



## Pin Description

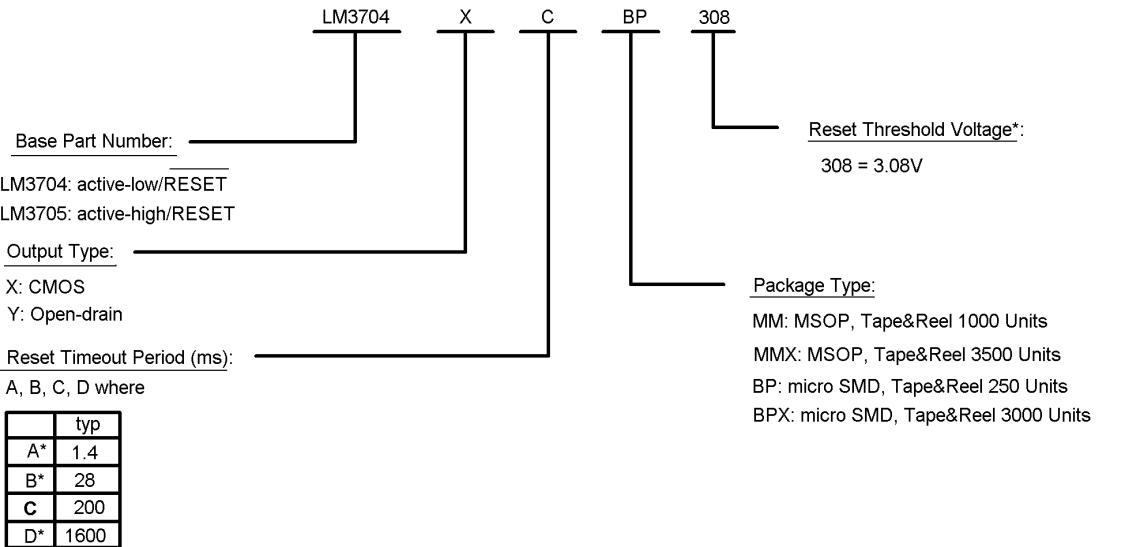
Pin No.		Name	Function
micro SMD	MSOP		
A1	2	$\overline{MR}$	Manual-Reset input. When $\overline{MR}$ is less than $V_{MRT}$ (Manual Reset Threshold) RESET/RESET is engaged.
B1	1	$V_{CC}$	Power Supply input.
C1	10	$\overline{RESET}$	Reset Logic Output. Pulses low for $t_{RP}$ (Reset Timeout Period) when triggered, and stays low whenever $V_{CC}$ is below the reset threshold or when $\overline{MR}$ is below $V_{MRT}$ . It remains low for $t_{RP}$ after either $V_{CC}$ rises above the reset threshold, or after $\overline{MR}$ input rises above $V_{MRT}$ (LM3704 only).
		RESET	Reset Logic Output. RESET is the inverse of $\overline{RESET}$ (LM3705 only).
C2	8	$\overline{PFO}$	Power-Fail Logic Output. When PFI is below $V_{PFT}$ , $\overline{PFO}$ goes low; otherwise, $\overline{PFO}$ remains high.
C3	7	$\overline{LLO}$	Low-Line Logic Output. Early Power-Fail warning output. Low when $V_{CC}$ falls below $V_{LLOT}$ (Low-Line Output Threshold). This output can be used to generate an NMI (Non-Maskable Interrupt) to provide an early warning of imminent power-failure.
B3	5	GND	Ground reference for all signals.
A3	4, 6	NC	No Connect.
A2	3	PFI	Power-Fail Comparator Input. When PFI is less than $V_{PFT}$ (Power-Fail Reset Threshold), the $\overline{PFO}$ goes low; otherwise, $\overline{PFO}$ remains high.
B2	9	NC	No Connect. Test input used at factory only. Leave floating.

## Block Diagram



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## Ordering Information



\* = available upon request. Contact National Semiconductor

\*For other voltages between 2.2V and 5.0V, please contact National Semiconductor sales office.

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## LM3704/LM3705

Part Number	Output	Reset Timeout Period	Package		Package Marking
			MSOP	micro SMD	
LM3704XBBP-232	totem-pole	28ms		x	%%I13
LM3704XBBPX-232	totem-pole	28ms		x	%%I13
LM3704XBBP-463	totem-pole	28ms		x	%%I27
LM3704XBBPX-463	totem-pole	28ms		x	%%I27
LM3704XBMM-232	totem-pole	28ms	x		R66B
LM3704XBMMX-232	totem-pole	28ms	x		R66B
LM3704XBMM-463	totem-pole	28ms	x		R27B
LM3704XBMMX-463	totem-pole	28ms	x		R27B
LM3704XCBP-308	totem-pole	200ms		x	%%I4
LM3704XCBPX-308	totem-pole	200ms		x	%%I4
LM3704XCMM-263	totem-pole	200ms	x		R79B
LM3704XCMMX-263	totem-pole	200ms	x		R79B
LM3704XCMM-308	totem-pole	200ms	x		R35B
LM3704XCMMX-308	totem-pole	200ms	x		R35B
LM3704XDBP-232	totem-pole	1600ms		x	%%I15
LM3704XDBPX-232	totem-pole	1600ms		x	%%I15
LM3704XDBP-463	totem-pole	1600ms		x	%%I17
LM3704XDBPX-463	totem-pole	1600ms		x	%%I17
LM3704XDMM-220	totem-pole	1600ms	x		R65B
LM3704XDMMX-220	totem-pole	1600ms	x		R65B
LM3704XDMM-232	totem-pole	1600ms	x		R67B
LM3704XDMMX-232	totem-pole	1600ms	x		R67B
LM3704XDMM-463	totem-pole	1600ms	x		R68B
LM3704XDMMX-463	totem-pole	1600ms	x		R68B
LM3704YAMM-308	open-drain	1.4ms	x		R78B
LM3704YAMMX-308	open-drain	1.4ms	x		R78B

## Ordering Information (Continued)

### LM3704/LM3705 (Continued)

Part Number	Output	Reset Timeout Period	Package		Package Marking
			MSOP	micro SMD	
LM3704YBMM-360	open-drain	28ms	x		R49B
LM3704YBMMX-360	open-drain	28ms	x		R49B
LM3704YCMM-232	open-drain	200ms	x		R76B
LM3704YCMMX-232	open-drain	200ms	x		R76B
LM3704YCMM-308	open-drain	200ms	x		R48B
LM3704YCMMX-308	open-drain	200ms	x		R48B
LM3705XBBP-232	totem-pole	28ms		x	%%l14
LM3705XBBPX-232	totem-pole	28ms		x	%%l14
LM3705XBBP-463	totem-pole	28ms		x	%%l33
LM3705XBBPX-463	totem-pole	28ms		x	%%l33
LM3705XBMM-232	totem-pole	28ms	x		R69B
LM3705XBMMX-232	totem-pole	28ms	x		R69B
LM3705XBMM-463	totem-pole	28ms		x	R44B
LM3705XBMMX-463	totem-pole	28ms		x	R44B
LM3705XCBP-463	totem-pole	200ms		x	%%l5
LM3705XCBPX-463	totem-pole	200ms		x	%%l5
LM3705XCMM-308	totem-pole	200ms	x		R36B
LM3705XCMMX-308	totem-pole	200ms	x		R36B
LM3705XDBP-232	totem-pole	1600ms		x	%%l16
LM3705XDBPX-232	totem-pole	1600ms		x	%%l16
LM3705XDBP-463	totem-pole	1600ms		x	%%l18
LM3705XDBPX-463	totem-pole	1600ms		x	%%l18
LM3705XDMM-232	totem-pole	1600ms	x		R70B
LM3705XDMMX-232	totem-pole	1600ms	x		R70B
LM3705XDMM-463	totem-pole	1600ms	x		R71B
LM3705XDMMX-463	totem-pole	1600ms	x		R71B

%% is the datecode and will vary with time.

## Table of Functions

Part Number	Active Low Reset	Active High Reset	Output (X = totem-pole) (Y = open-drain)	Reset Timeout Period	Manual Reset	Power Fail Comparator	Low Line Output
LM3704	x		X, Y*	Customized	x	x	x
LM3705		x	X	Customized	x	x	x

\* = available upon request. Contact National

**Absolute Maximum Ratings** (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage ( $V_{CC}$ )	-0.3V to 6.0V
All Other Inputs	-0.3V to $V_{CC}$ + 0.3V
ESD Ratings (Note 2)	
Human Body Model	1.5kV
Machine Model	150V

Power Dissipation

(Note 3)

**Operating Ratings** (Note 1)Temperature Range  $-40^{\circ}\text{C} \leq T_J \leq 85^{\circ}\text{C}$ **LM3704/LM3705 Series Electrical Characteristics**

Limits in the standard typeface are for  $T_J = 25^{\circ}\text{C}$  and limits in **boldface** type apply over full operating range. Unless otherwise specified:  $V_{CC} = +2.2\text{V}$  to  $5.5\text{V}$ .

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>POWER SUPPLY</b>						
$V_{CC}$	Operating Voltage Range: $V_{CC}$	LM3704	1.0		5.5	V
		LM3705	1.2		5.5	
$I_{CC}$	$V_{CC}$ Supply Current	All inputs = $V_{CC}$ ; all outputs floating		28	50	$\mu\text{A}$
<b>RESET THRESHOLD</b>						
$V_{RST}$	Reset Threshold	$V_{CC}$ falling	-0.5	$V_{RST}$	+0.5	%
			-2		+2	
$V_{RSTH}$	Reset Threshold Hysteresis	$V_{CC}$ falling: $T_A = 0^{\circ}\text{C}$ to $70^{\circ}\text{C}$	-1.5		+1.5	
				0.0032• $V_{RST}$		mV
$t_{RP}$	Reset Timeout Period	Reset Timeout Period = A	1	1.4	2	ms
		Reset Timeout Period = B	20	28	40	
		Reset Timeout Period = C	140	200	280	
		Reset Timeout Period = D	1120	1600	2240	
$t_{RD}$	$V_{CC}$ to Reset Delay	$V_{CC}$ falling at $1\text{mV}/\mu\text{s}$		20		$\mu\text{s}$
<b>RESET (LM3705)</b>						
$V_{OL}$	RESET	$V_{CC} > 2.25\text{V}$ , $I_{SINK} = 900\mu\text{A}$			0.3	V
		$V_{CC} > 2.7\text{V}$ , $I_{SINK} = 1.2\text{mA}$			0.3	
		$V_{CC} > 4.5\text{V}$ , $I_{SINK} = 3.2\text{mA}$			0.4	
$V_{OH}$	RESET	$V_{CC} > 1.2\text{V}$ , $I_{SOURCE} = 50\mu\text{A}$	0.8 $V_{CC}$			V
		$V_{CC} > 1.8\text{V}$ , $I_{SOURCE} = 150\mu\text{A}$	0.8 $V_{CC}$			
		$V_{CC} > 2.25\text{V}$ , $I_{SOURCE} = 300\mu\text{A}$	0.8 $V_{CC}$			
		$V_{CC} > 2.7\text{V}$ , $I_{SOURCE} = 500\mu\text{A}$	0.8 $V_{CC}$			
		$V_{CC} > 4.5\text{V}$ , $I_{SOURCE} = 800\mu\text{A}$	$V_{CC} - 1.5\text{V}$			
$I_{LKG}$	Output Leakage Current	$V_{RESET} = 5.5\text{V}$			1.0	$\mu\text{A}$
<b>RESET (LM3704)</b>						
$V_{OL}$	RESET	$V_{CC} > 1.0\text{V}$ , $I_{SINK} = 50\mu\text{A}$			0.3	V
		$V_{CC} > 1.2\text{V}$ , $I_{SINK} = 100\mu\text{A}$			0.3	
		$V_{CC} > 2.25\text{V}$ , $I_{SINK} = 900\mu\text{A}$			0.3	
		$V_{CC} > 2.7\text{V}$ , $I_{SINK} = 1.2\text{mA}$			0.3	
		$V_{CC} > 4.5\text{V}$ , $I_{SINK} = 3.2\text{mA}$			0.4	
$V_{OH}$	RESET	$V_{CC} > 2.25\text{V}$ , $I_{SOURCE} = 300\mu\text{A}$	0.8 $V_{CC}$			V
		$V_{CC} > 2.7\text{V}$ , $I_{SOURCE} = 500\mu\text{A}$	0.8 $V_{CC}$			
		$V_{CC} > 4.5\text{V}$ , $I_{SOURCE} = 800\mu\text{A}$	$V_{CC} - 1.5\text{V}$			

## LM3704/LM3705 Series Electrical Characteristics (Continued)

Limits in the standard typeface are for  $T_J = 25^\circ\text{C}$  and limits in **boldface type** apply over full operating range. Unless otherwise specified:  $V_{CC} = +2.2\text{V}$  to  $5.5\text{V}$ .

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>PFI/MR</b>						
$V_{PFT}$	PFI Input Threshold		<b>1.200</b>	1.225	<b>1.250</b>	V
$V_{MRT}$	MR Input Threshold	MR, Low			<b>0.8</b>	V
		MR, High	<b>2.0</b>			
$V_{PFTH}/V_{MRTH}$	PFI/MR Threshold Hysteresis	PFI/MR falling: $V_{CC} = V_{RST}$ MAX to $5.5\text{V}$		$0.0032 \cdot V_{RST}$		mV
$I_{PFI}$	Input Current (PFI only)		<b>-75</b>		<b>75</b>	nA
$R_{MR}$	MR Pull-up Resistance		<b>35</b>	56	<b>75</b>	k $\Omega$
$t_{MD}$	MR to Reset Delay			12		$\mu\text{s}$
$t_{MR}$	MR Pulse Width		<b>25</b>			$\mu\text{s}$
<b>PFO, LLO</b>						
$V_{OL}$	PFO, LLO Output Voltage	$V_{CC} > 2.25\text{V}$ , $I_{SINK} = 900\mu\text{A}$			<b>0.3</b>	V
		$V_{CC} > 2.7\text{V}$ , $I_{SINK} = 1.2\text{mA}$			<b>0.3</b>	
		$V_{CC} > 4.5\text{V}$ , $I_{SINK} = 3.2\text{mA}$			<b>0.4</b>	
$V_{OH}$		$V_{CC} > 2.25\text{V}$ , $I_{SOURCE} = 300\mu\text{A}$	<b>0.8 <math>V_{CC}</math></b>			
		$V_{CC} > 2.7\text{V}$ , $I_{SOURCE} = 500\mu\text{A}$	<b>0.8 <math>V_{CC}</math></b>			
		$V_{CC} > 4.5\text{V}$ , $I_{SOURCE} = 800\mu\text{A}$	$V_{CC} - 1.5\text{V}$			
<b>LLO OUTPUT</b>						
$V_{LLOT}$	LLO Output Threshold ( $V_{LLO} - V_{RST}$ , $V_{CC}$ falling)		<b>1.01 <math>\cdot V_{RST}</math></b>	$1.02 \cdot V_{RST}$	<b>1.03 <math>\cdot V_{RST}</math></b>	V
$V_{LLOTH}$	Low-Line Comparator Hysteresis			$0.0032 \cdot V_{RST}$		mV
$t_{CD}$	Low-Line Comparator Delay	$V_{CC}$ falling at $1\text{mV}/\mu\text{s}$		20		$\mu\text{s}$

**Note 1: Absolute Maximum Ratings** indicate limits beyond which damage to the device may occur. **Operating Ratings** indicate conditions for which the device is intended to be functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed conditions.

**Note 2:** The Human Body model is a 100 pF capacitor discharged through a 1.5 k $\Omega$  resistor into each pin. The machine model is a 200pF capacitor discharged directly into each pin.

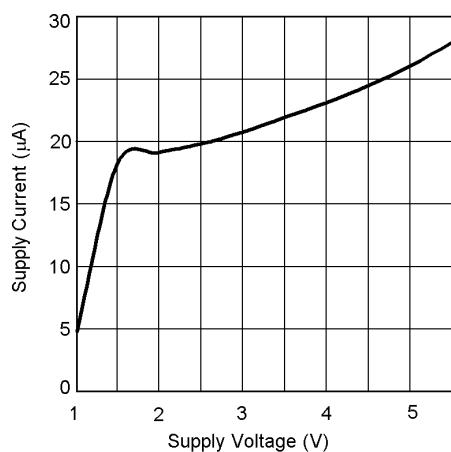
**Note 3:** The maximum allowable power dissipation is a function of the maximum junction temperature,  $T_J(\text{MAX})$ , the junction-to-ambient thermal resistance,  $\theta_{J-A}$ , and the ambient temperature,  $T_A$ . The maximum allowable power dissipation at any ambient temperature is calculated using:

$$P(\text{MAX}) = \frac{T_J(\text{MAX}) - T_A}{\theta_{J-A}}$$

Where the value of  $\theta_{J-A}$  for the MSOP-10 package is  $195^\circ\text{C}/\text{W}$  in a typical PC board mounting and the micro SMD package is  $220^\circ\text{C}/\text{W}$ .

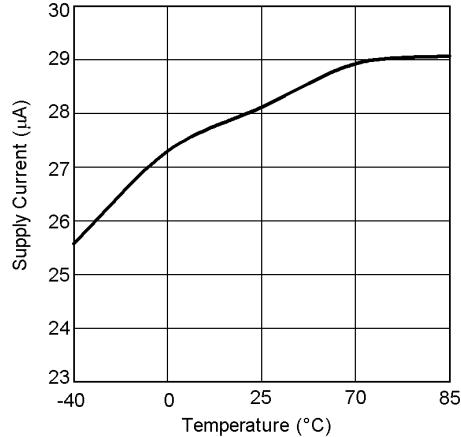
## Typical Performance Characteristics

Supply Current vs Supply Voltage



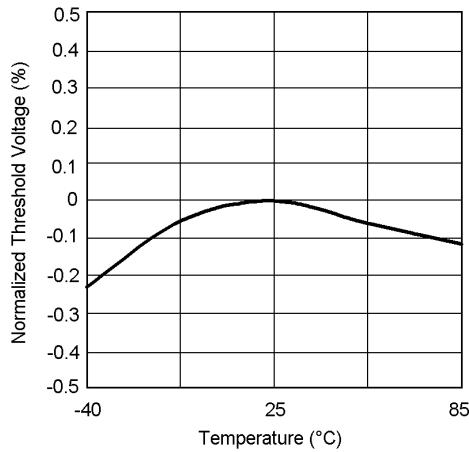
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3.3V Supply Current vs Temperature



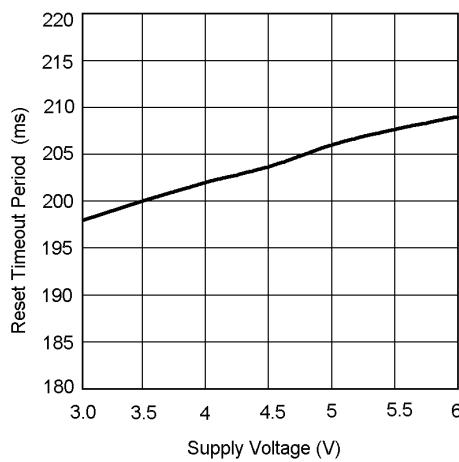
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Normalized Reset Threshold Voltage vs Temperature



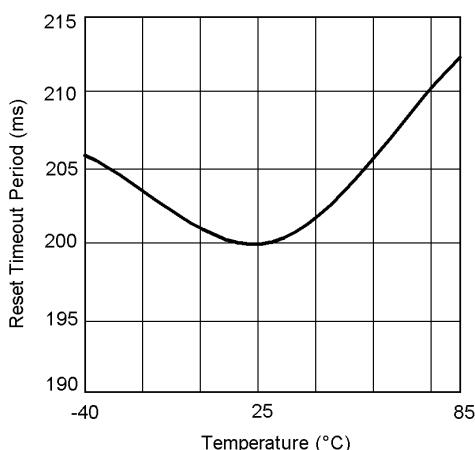
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Reset Timeout Period vs  $V_{CC}$



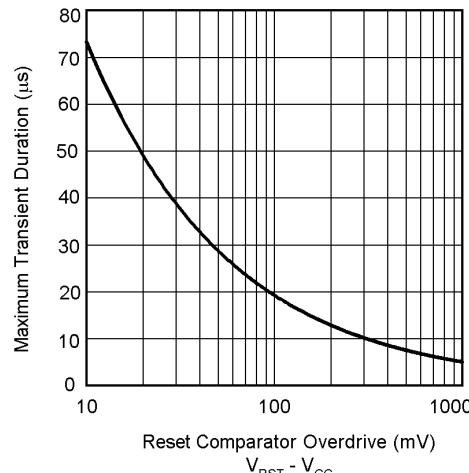
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Reset Timeout Period vs Temperature



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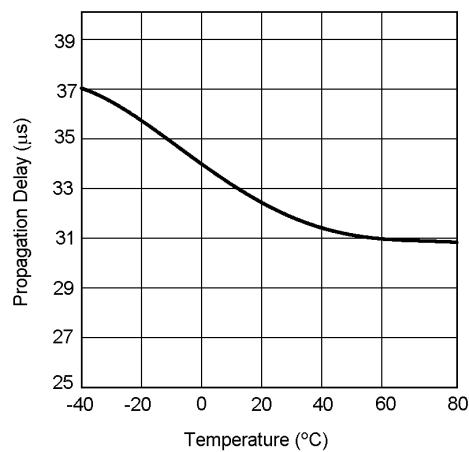
Max. Transient Duration vs Reset Comparator Overdrive  
( $V_{CC} = 3.3V$ )



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## Typical Performance Characteristics (Continued)

### Low-Line Comparator Propagation Delay vs Temperature



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## Circuit Information

### RESET OUTPUT

The Reset input of a  $\mu$ P initializes the device into a known state. The LM3704/LM3705 microprocessor supervisory circuits assert a forced reset output to prevent code execution errors during power-up, power-down, and brownout conditions.

$\overline{\text{RESET}}$  is guaranteed valid for  $V_{CC} > 1\text{V}$ . Once  $V_{CC}$  exceeds the reset threshold, an internal timer maintains the output for the reset timeout period. After this interval, reset goes high. The LM3704 offers an active-low  $\overline{\text{RESET}}$ ; The LM3705 offers an active-high  $\text{RESET}$ .

Any time  $V_{CC}$  drops below the reset threshold (such as during a brownout), the reset activates. When  $V_{CC}$  again rises above the reset threshold, the internal timer starts. Reset holds until  $V_{CC}$  exceeds the reset threshold for longer than the reset timeout period. After this time, reset releases. The Manual Reset input ( $\overline{\text{MR}}$ ) will initiate a forced reset also. See the *Manual Reset Input* section.

### RESET THRESHOLD

The LM3704/LM3705 family is available with a reset voltage of 3.08V. Other reset thresholds in the 2.20V to 5.0V range, in steps of 10 mV, are available; contact National Semiconductor for details.

### MANUAL RESET INPUT ( $\overline{\text{MR}}$ )

Many  $\mu$ P-based products require a manual reset capability, allowing the operator to initiate a reset. The  $\overline{\text{MR}}$  input is fully debounced and provides an internal 56 k $\Omega$  pull-up. When the  $\overline{\text{MR}}$  input is pulled below  $V_{MRT}$  (1.225V) for more than 25  $\mu$ s, reset is asserted after a typical delay of 12  $\mu$ s. Reset remains active as long as  $\overline{\text{MR}}$  is held low, and releases after the reset timeout period expires after  $\overline{\text{MR}}$  rises above  $V_{MRT}$ . Use  $\overline{\text{MR}}$  with digital logic to assert or to daisy chain supervisory circuits. It may be used as another low-line comparator by adding a buffer.

### POWER-FAIL COMPARATOR (PFI/PFO)

The PFI is compared to a 1.225V internal reference,  $V_{PFT}$ . If PFI is less than  $V_{PFT}$ , the Power Fail Output  $\overline{\text{PFO}}$  drops low. The power-fail comparator signals a falling power supply, and is driven typically by an external voltage divider that senses either the unregulated supply or another system

supply voltage. The voltage divider generally is chosen so the voltage at PFI drops below  $V_{PFT}$  several milliseconds before the main supply voltage drops below the reset threshold, providing advanced warning of a brownout.

The voltage threshold is set by  $R_1$  and  $R_2$  and is calculated as follows:

$$V_{PFT} = \left( \frac{R_1 + R_2}{R_2} \right) \times 1.225\text{V}$$

Note this comparator is completely separate from the rest of the circuitry, and may be employed for other functions as needed.

### LOW-LINE OUTPUT (LLO)

The low-line output comparator is typically used to provide a non-maskable interrupt to a  $\mu$ P when  $V_{CC}$  begins falling. LLO monitors  $V_{CC}$  and goes low when  $V_{CC}$  falls below  $V_{LLOT}$  (typically  $1.02 \cdot V_{RST}$ ) with hysteresis of  $0.0032 \cdot V_{RST}$ .

### SPECIAL PRECAUTIONS FOR THE MICRO SMD PACKAGE

As with most integrated circuits, the LM3704 and LM3705 are sensitive to exposure from visible and infrared (IR) light radiation. Unlike a plastic encapsulated IC, the micro SMD package has very limited shielding from light, and some sensitivity to light reflected from the surface of the PC board or long wavelength IR entering the die from the side may be experienced. This light could have an unpredictable affect on the electrical performance of the IC. Care should be taken to shield the device from direct exposure to bright visible or IR light during operation.

### MICRO SMD MOUNTING

The micro SMD package requires specific mounting techniques which are detailed in National Semiconductor Application Note AN-1112. Referring to the section **Surface Mount Technology (SMT) Assembly Considerations**, it should be noted that the pad style which must be used with the 9-pin package is the NSMD (non-solder mask defined) type.

For best results during assembly, alignment ordinals on the PC board may be used to facilitate placement of the micro SMD device.

## Timing Diagrams

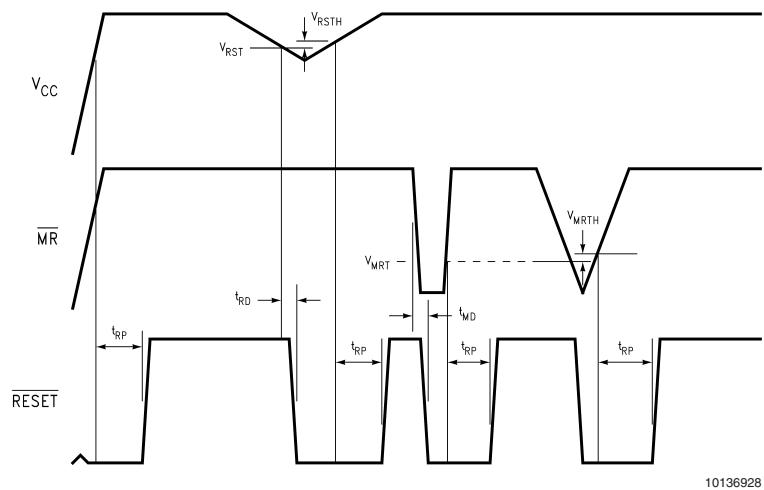


FIGURE 1. LM3704 Reset Time with  $\overline{MR}$

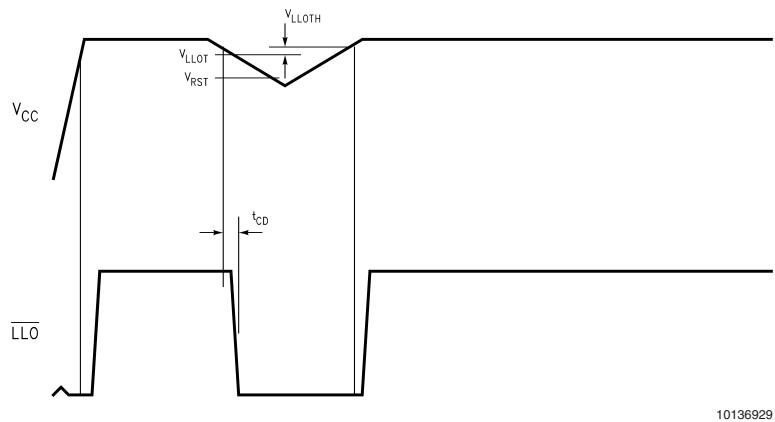


FIGURE 2.  $\overline{LLO}$  Output

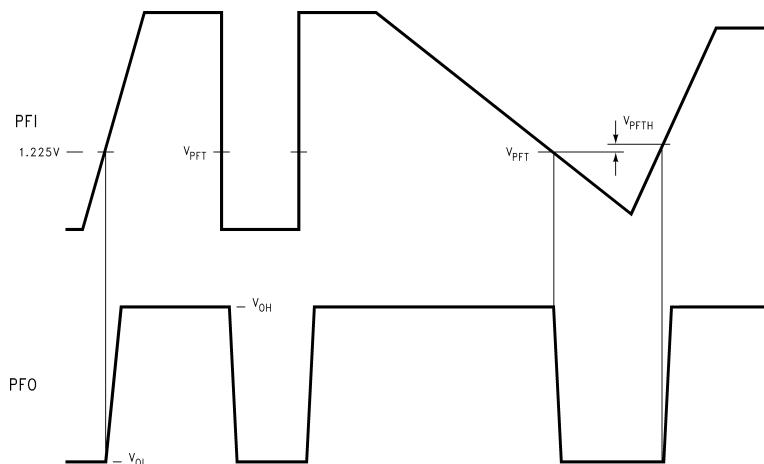


FIGURE 3. PFI Comparator Timing Diagram

## Typical Application Circuits

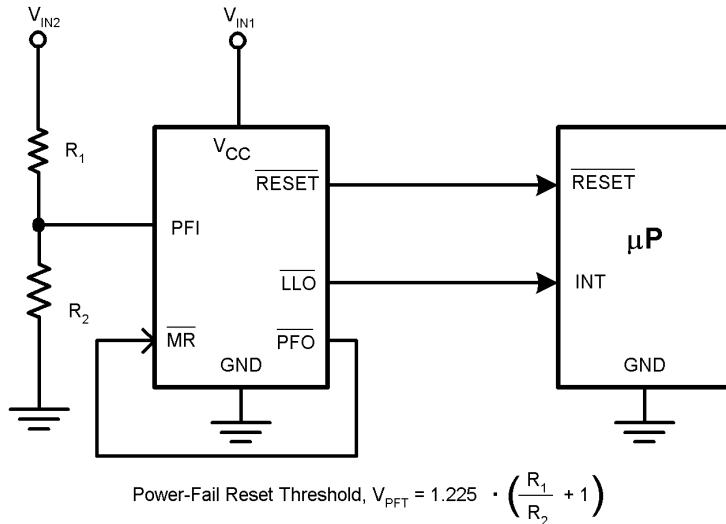


FIGURE 4. Monitoring Two Critical Supplies

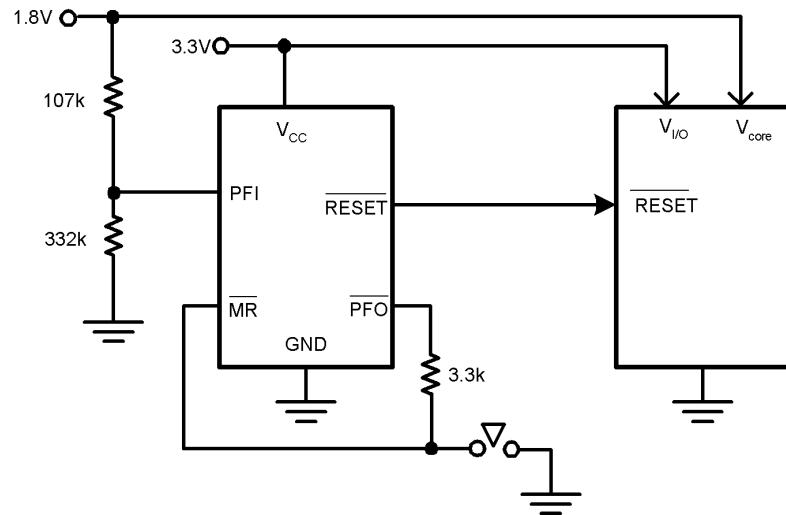
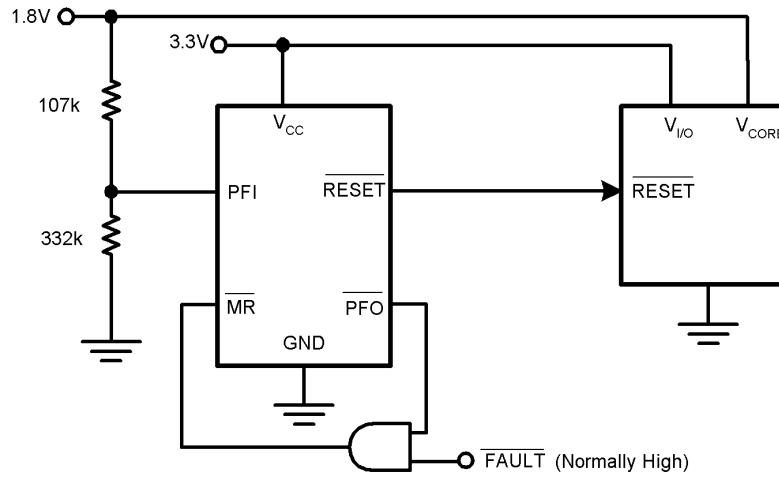


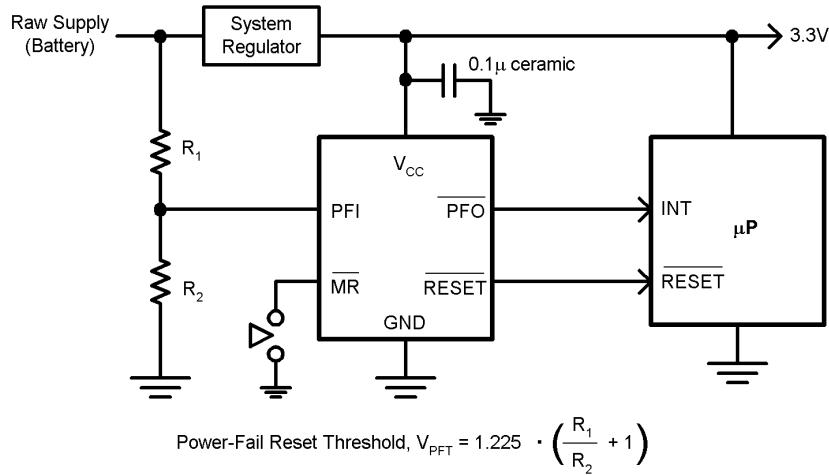
FIGURE 5. Monitoring Two Supplies plus Manual Reset

## Typical Application Circuits (Continued)



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FIGURE 6. Monitoring Dual Supplies plus External Fault Input

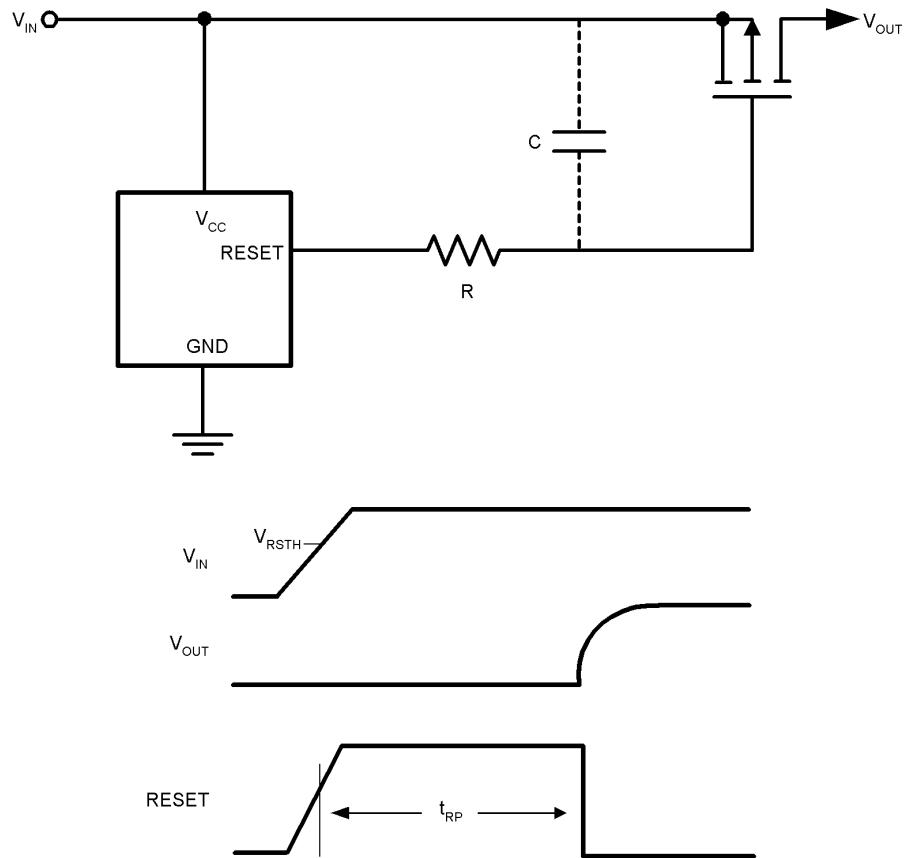


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Note:  $\overline{MR}$  input with its 1.225V nominal threshold, may monitor an additional supply voltage. An internal 56 kΩ pull-up resistor is included on this input.

FIGURE 7. Microprocessor Supervisor with Early Warning Detector

## Typical Application Circuits (Continued)



10136924

FIGURE 8. LM3705 Power-On Delay

## Typical Application Circuits (Continued)

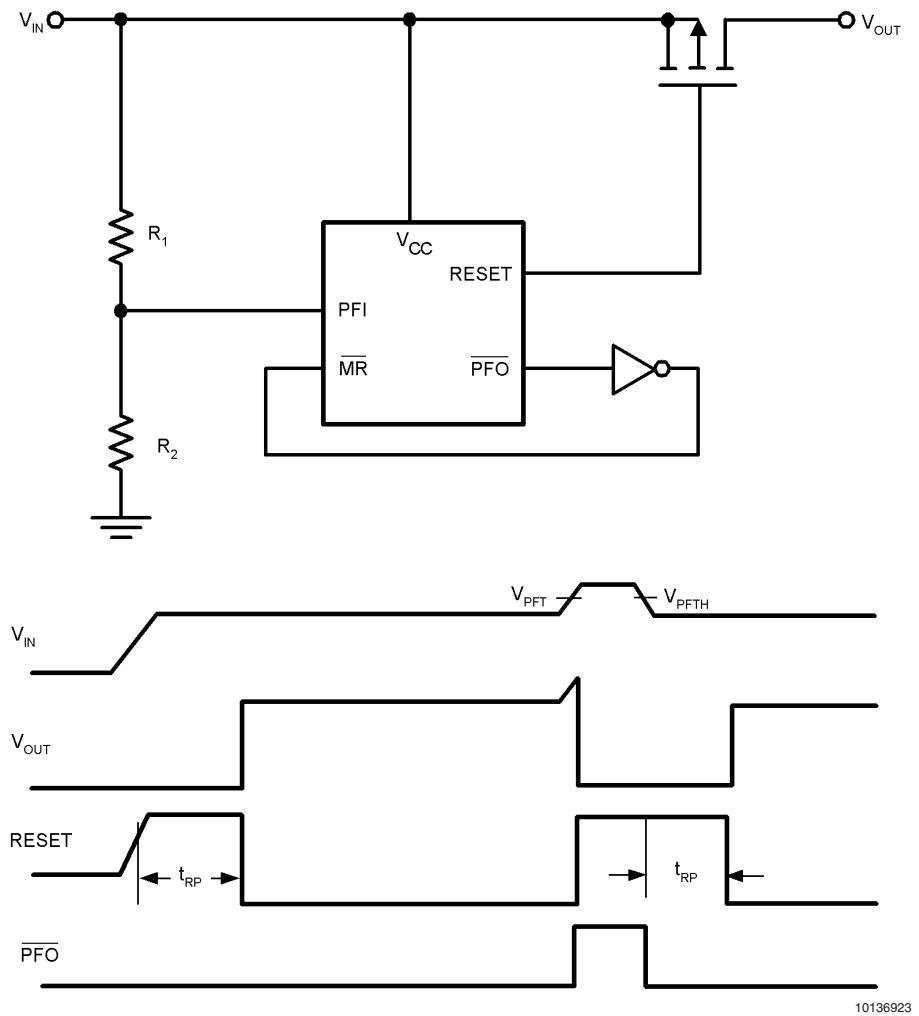


FIGURE 9. LM3705 Power-On Delay with Overvoltage Protection

## Typical Application Circuits (Continued)

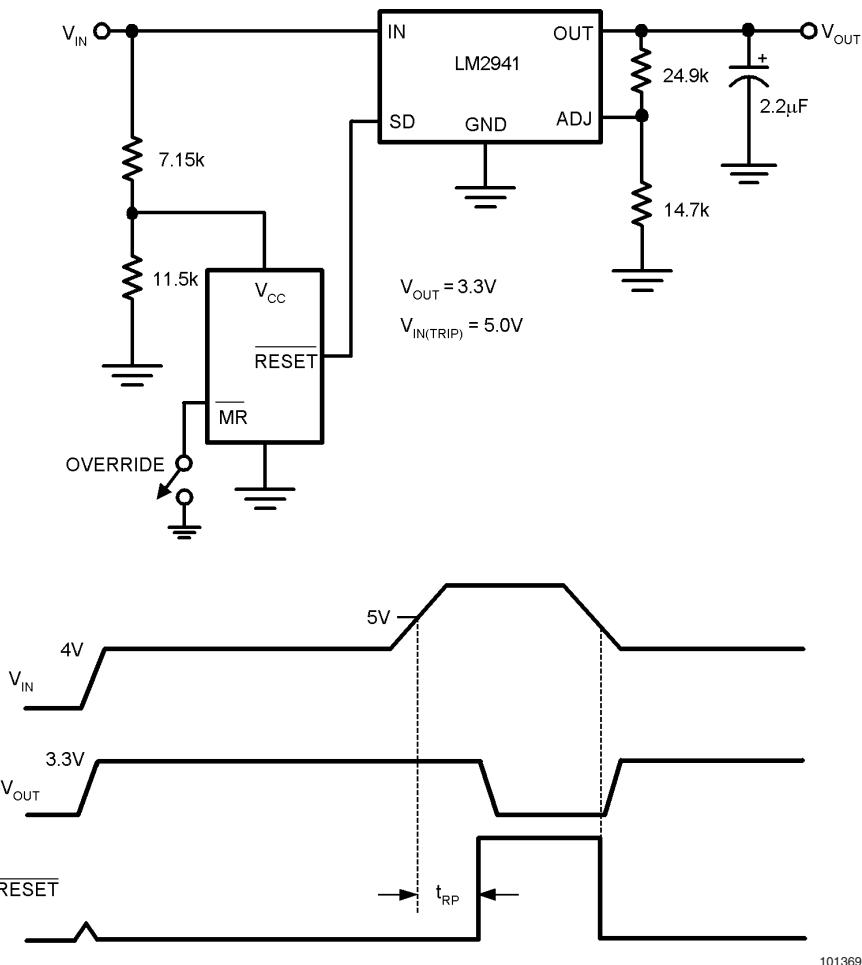


FIGURE 10. Regulator/Switch with Long-Term Overvoltage Lockout Prevents Overdissipation in Linear Regulator

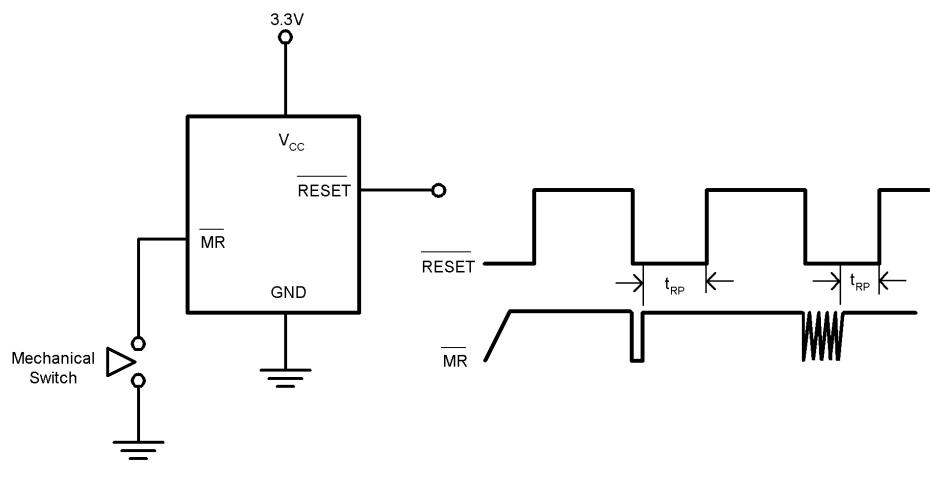
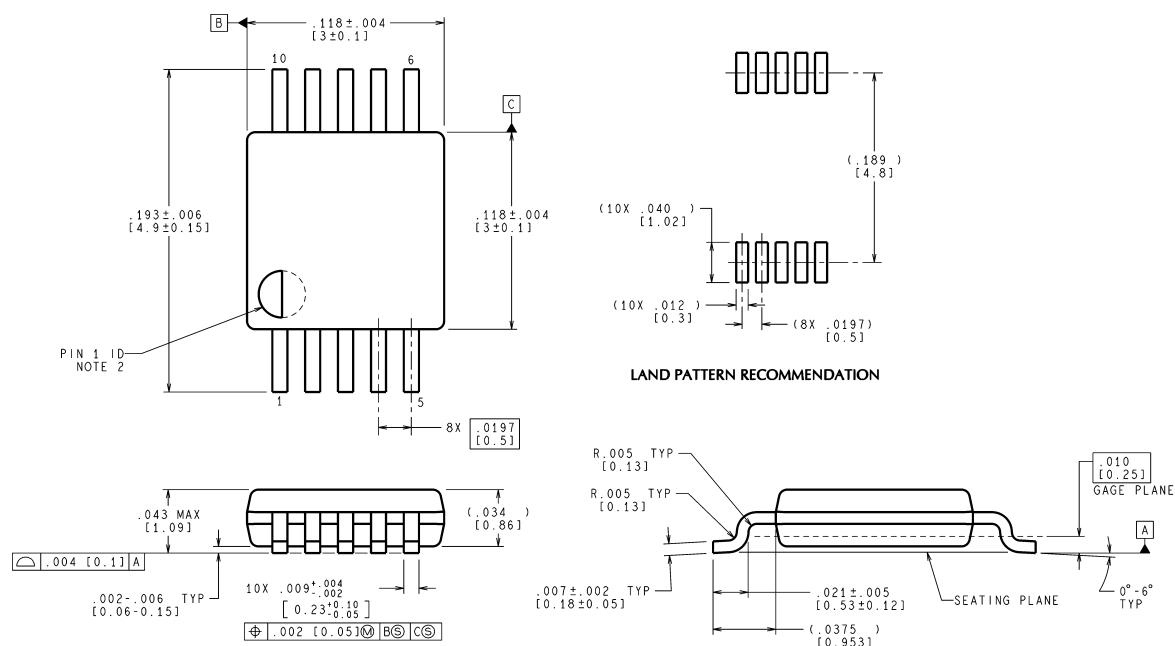


FIGURE 11. Switch Debouncer

## Physical Dimensions inches (millimeters)

unless otherwise noted



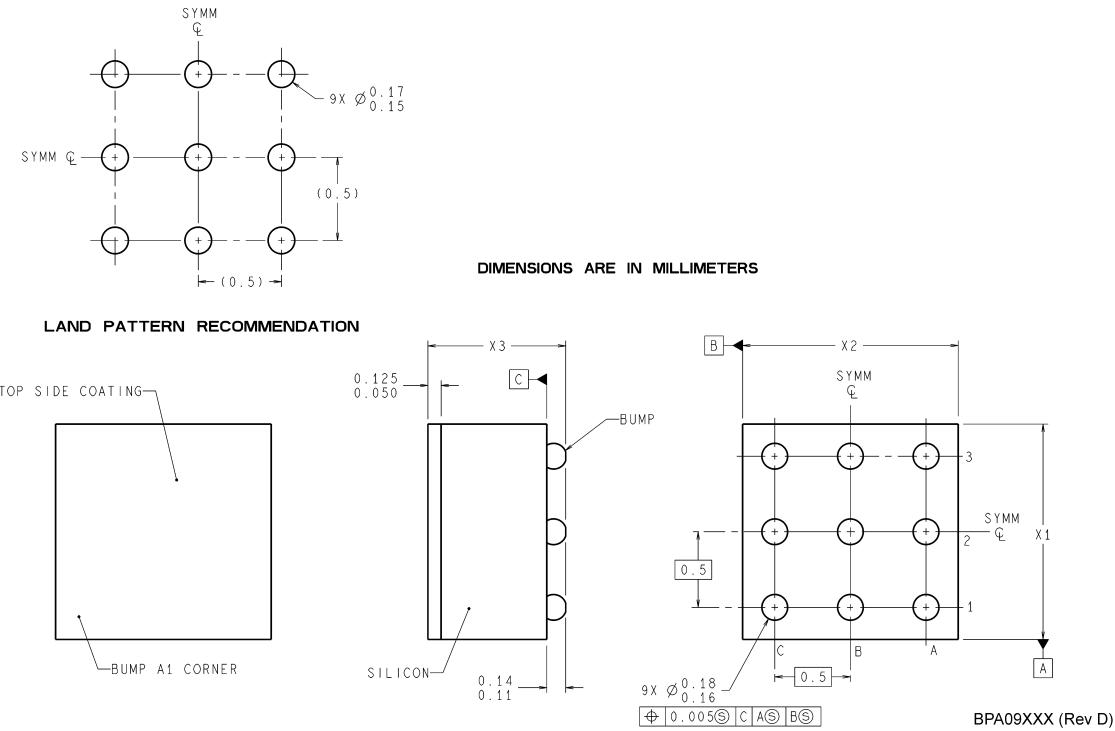
CONTROLLING DIMENSION IS INCH  
VALUES IN [ ] ARE MILLIMETERS  
DIMENSIONS IN ( ) FOR REFERENCE ONLY

MUB10A (Rev B)

**10 Lead MSOP Package**  
**NS Package Number MUB10A**

## Physical Dimensions

inches (millimeters) unless otherwise noted (Continued)



### NOTES: UNLESS OTHERWISE SPECIFIED

1. EPOXY COATING
2. 63Sn/37Pb EUTECTIC BUMP
3. RECOMMEND NON-SOLDER MASK DEFINED LANDING PAD.
4. PIN 1 IS ESTABLISHED BY LOWER LEFT CORNER WITH RESPECT TO TEXT ORIENTATION. REMAINING PINS ARE NUMBERED COUNTER CLOCKWISE.
5. XXX IN DRAWING NUMBER REPRESENTS PACKAGE SIZE VARIATION WHERE X1 IS PACKAGE WIDTH, X2 IS PACKAGE LENGTH AND X3 IS PACKAGE HEIGHT.
6. NO JEDEC REGISTRATION AS OF AUG.1999.

**9 bump micro SMD Package**  
**NS Package Number BPA09FFB**  
**The dimensions of X1, X2 and X3 are given below**  
**X1 = 1.412mm**  
**X2 = 1.412mm**  
**X3 = 0.850mm**

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